

## Supplemental Information

This notice describes the differences between the updated version and its previous version of the IDT82V2052E Data Sheet. It helps readers to identify the changes when the data sheet is upgraded.

## Revision History

Revision Date	PCN Number (if applicable)	Date Code	Changed Items
December 12, 2005	-	-	1-11

## Changed Items

### December 12, 2005

- Item 11:** Changed the ATAO bit description. (Page 43)
- Item 10:** Added pin compatible device names. (Page 1)
- Item 9:** Added green package options (Page 1, 70)
- Item 8:** Added MCLK requirement for the  $\overline{\text{RST}}$  pin. (Page 15)
- Item 7:** Added how to connect JTAG pins when JTAG is not used. (Page 15)
- Item 6:** Changed Figure-5 (Page 21)
- Item 5:** Changed notes for Figure-6 (Page 21)
- Item 4:** Changed 3.7.1 Analog Loopback (Page 27)
- Item 3:** Changed description for Reset Operation (Page 35)
- Item 2:** Added setting for reserved registers (Page 36)
- Item 1:** Added test conditions for Isc (Page 59)

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